

# 128K x 8 Static RAM

#### **Features**

- High speed
  - $t_{AA} = 10, 12, 15 \text{ ns}$
- CMOS for optimum speed/power
- Center power/ground pinout
- · Automatic power-down when deselected
- Easy memory expansion with  $\overline{\text{CE}}$  and  $\overline{\text{OE}}$  options
- Functionally equivalent to CY7C1019

## **Functional Description**

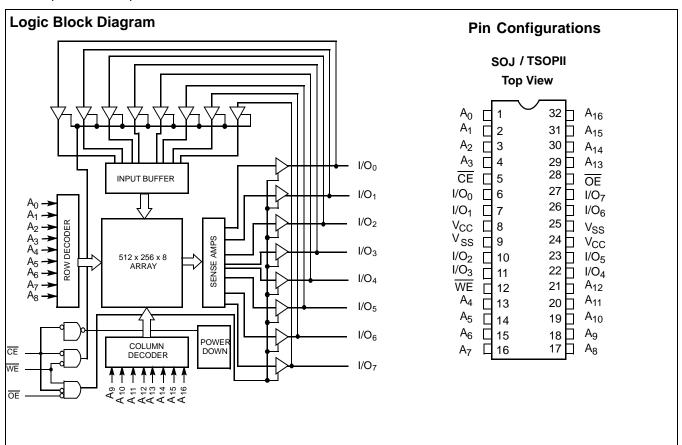
The CY7C1019B/10191B is a high-performance CMOS static RAM organized as 131,072 words by 8 bits. Easy memory expansion is provided by an active LOW Chip Enable ( $\overline{CE}$ ), an active LOW Output Enable (OE), and three-state drivers. This device has an automatic power-down feature that significantly reduces power consumption when deselected.

Writing to the device is accomplished by taking Chip Enable (CE) and Write Enable (WE) inputs LOW. Data on the eight I/O pins (I/O<sub>0</sub> through I/O<sub>7</sub>) is then written into the location specified on the address pins (A<sub>0</sub> through A<sub>16</sub>).

Reading from the device is accomplished by taking Chip Enable (CE) and Output Enable (OE) LOW while forcing Write Enable (WE) HIGH. Under these conditions, the contents of the memory location specified by the address pins will appear on the I/O pins.

The eight input/output pins (I/O<sub>0</sub> through I/O<sub>7</sub>) are placed in a high-impedance state when the device is deselected (CE HIGH), the outputs are disabled (OE HIGH), or during a write operation ( $\overline{CE}$  LOW, and  $\overline{WE}$  LOW).

The CY7C1019B/10191B is available in standard 32-pin TSOP Type II and 400-mil-wide SOJ packages. Customers should use part number CY7C10191B when ordering parts with 10 ns tAA, and CY7C1019B when ordering 12 and 15 ns





#### **Selection Guide**

		7C10191B-10	7C1019B-12	7C1019B-15	Unit
Maximum Access Time		10	12	15	ns
Maximum Operating Current		150	140	130	mA
Maximum Standby Current		10	10	10	mA
	L	_	1	1	mA

## **Maximum Ratings**

(Above which the useful life may be impaired. For user guidelines, not tested.)

Storage Temperature .....-65°C to +150°C

Ambient Temperature with

Power Applied......–55°C to +125°C

Supply Voltage on  $V_{CC}$  to Relative  $GND^{[1]}$  .... –0.5V to +7.0V

DC Voltage Applied to Outputs in High Z State  $^{[1]}$  .....-0.5V to  $V_{CC}$  + 0.5V

DC Input Voltage<sup>[1]</sup>.....-0.5V to  $V_{CC}$  + 0.5V

Current into Outputs (LOW)	20 mA
Static Discharge Voltage(per MIL-STD-883, Method 3015)	>2001V
Latch-Up Current	>200 mA

## **Operating Range**

Range	Ambient Temperature <sup>[2]</sup>	V <sub>CC</sub>
Commercial	0°C to +70°C	5V ± 10%
Industrial	-40°C to +85°C	5V ± 10%

## **Electrical Characteristics** Over the Operating Range

			7C101	91B-10	7C101	19B-12	7C101	19B-15	
Parameter	Description	Test Conditions	Min.	Max.	Min.	Max.	Min.	Max.	Unit
V <sub>OH</sub>	Output HIGH Voltage	$V_{CC} = Min.,$ $I_{OH} = -4.0 \text{ mA}$	2.4		2.4		2.4		V
V <sub>OL</sub>	Output LOW Voltage	V <sub>CC</sub> = Min., I <sub>OL</sub> = 8.0 mA		0.4		0.4		0.4	V
V <sub>IH</sub>	Input HIGH Voltage		2.2	V <sub>CC</sub> + 0.3	2.2	V <sub>CC</sub> + 0.3	2.2	V <sub>CC</sub> + 0.3	V
V <sub>IL</sub>	Input LOW Voltage <sup>[1]</sup>		-0.3	0.8	-0.3	0.8	-0.3	0.8	V
I <sub>IX</sub>	Input Load Current	$GND \le V_1 \le V_{CC}$	-1	+1	-1	+1	-1	+1	μА
I <sub>OZ</sub>	Output Leakage Current	$\begin{aligned} &\text{GND} \leq \text{V}_{\text{I}} \leq \text{V}_{\text{CC}}, \\ &\text{Output Disabled} \end{aligned}$	<b>-</b> 5	+5	<b>-</b> 5	+5	<b>–</b> 5	+5	μА
I <sub>CC</sub>	V <sub>CC</sub> Operating Supply Current	$V_{CC} = Max.,$ $I_{OUT} = 0 \text{ mA},$ $f = f_{MAX} = 1/t_{RC}$		150		140		130	mA
I <sub>SB1</sub>	Automatic CE	Max. $V_{CC}$ , $\overline{CE} \ge V_{IH}$		40		40		40	mA
	Power-Down Current —TTL Inputs	$V_{IN} \ge V_{IH} \text{ or } V_{IN} \le V_{IL}, f = f_{MAX}$		20		20		20	
I <sub>SB2</sub>	Automatic CE	Max. V <sub>CC</sub> ,		10		10		10	mA
	Power-Down Current —CMOS Inputs	$CE \ge V_{CC} - 0.3V$ , $V_{IN} \ge V_{CC} - 0.3V$ , or $V_{IN} \le 0.3V$ , $f = 0$		_		1		1	

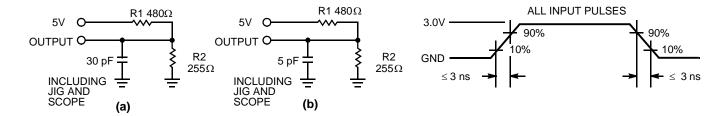
## Capacitance<sup>[3]</sup>

Parameter	Description	Test Conditions	Max.	Unit
C <sub>IN</sub>	Input Capacitance	$T_A = 25^{\circ}C, f = 1 \text{ MHz},$	6	pF
C <sub>OUT</sub>	Output Capacitance	$V_{CC} = 5.0V$	8	pF

- 1.  $V_{\rm IL}$  (min.) = -2.0V for pulse durations of less than 20 ns. 2.  $T_{\rm A}$  is the "Instant On" case temperature.
- 3. Tested initially and after any design or process changes that may affect these parameters.



#### **AC Test Loads and Waveforms**



Equivalent to: THÉVENIN EQUIVALENT OUTPUT O-

## Switching Characteristics<sup>[4]</sup> Over the Operating Range

		7C101	91B-10	7C10	19B-12	7C10 <sup>-</sup>	19B-15	
Parameter	Description	Min.	Max.	Min.	Max.	Min.	Max.	Unit
Read Cycle		1	1	•		•	•	
t <sub>RC</sub>	Read Cycle Time	10		12		15		ns
t <sub>AA</sub>	Address to Data Valid		10		12		15	ns
t <sub>OHA</sub>	Data Hold from Address Change	3		3		3		ns
t <sub>ACE</sub>	CE LOW to Data Valid		10		12		15	ns
t <sub>DOE</sub>	OE LOW to Data Valid		5		6		7	ns
t <sub>LZOE</sub>	OE LOW to Low Z	0		0		0		ns
t <sub>HZOE</sub>	OE HIGH to High Z <sup>[5, 6]</sup>		5		6		7	ns
t <sub>LZCE</sub>	CE LOW to Low Z <sup>[6]</sup>	3		3		3		ns
t <sub>HZCE</sub>	CE HIGH to High Z <sup>[5, 6]</sup>		5		6		7	ns
t <sub>PU</sub>	CE LOW to Power-Up	0		0		0		ns
t <sub>PD</sub>	CE HIGH to Power-Down		10		12		15	ns
Write Cycle <sup>[7</sup>	7, 8]							-
t <sub>WC</sub>	Write Cycle Time	10		12		15		ns
t <sub>SCE</sub>	CE LOW to Write End	8		9		10		ns
t <sub>AW</sub>	Address Set-Up to Write End	7		8		10		ns
t <sub>HA</sub>	Address Hold from Write End	0		0		0		ns
t <sub>SA</sub>	Address Set-Up to Write Start	0		0		0		ns
t <sub>PWE</sub>	WE Pulse Width	7		8		10		ns
t <sub>SD</sub>	Data Set-Up to Write End	5		6		8		ns
t <sub>HD</sub>	Data Hold from Write End	0		0		0		ns
t <sub>LZWE</sub>	WE HIGH to Low Z <sup>[6]</sup>	3		3		3		ns
t <sub>HZWE</sub>	WE LOW to High Z <sup>[5, 6]</sup>		5		6		7	ns

#### Notes:

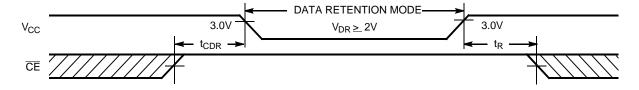
- 4. Test conditions assume signal transition time of 3 ns or less, timing reference levels of 1.5V, input pulse levels of 0 to 3.0V, and output loading of the specified I<sub>OL</sub>/I<sub>OH</sub> and 30-pF load capacitance.
- 5. tHZOE, tHZCE, and tHZWE are specified with a load capacitance of 5 pF as in part (b) of AC Test Loads. Transition is measured ±500 mV from steady-state voltage.
- At any given temperature and voltage condition, t<sub>HZCE</sub> is less than t<sub>LZCE</sub>, t<sub>HZOE</sub> is less than t<sub>LZCE</sub>, and t<sub>HZWE</sub> is less than t<sub>LZWE</sub> for any given device.
   The internal write time of the memory is defined by the overlap of CE LOW and WE LOW. CE and WE must be LOW to initiate a write, and the transition of any of these signals can terminate the write. The input data set-up and hold timing should be referenced to the leading edge of the signal that terminates the write.
- 8. The minimum write cycle time for Write Cycle no. 3 (WE controlled, OE LOW) is the sum of t<sub>HZWE</sub> and t<sub>SD</sub>.



## Data Retention Characteristics Over the Operating Range (L Version Only)

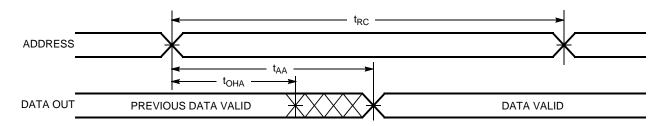
Parameter	Description	Conditions	Min.	Max.	Unit
V <sub>DR</sub>	V <sub>CC</sub> for Data Retention	No input may exceed V <sub>CC</sub> + 0.5V	2.0		V
I <sub>CCDR</sub>	Data Retention Current	$\frac{V_{CC}}{CE} = V_{DR} = 2.0V,$ $\frac{V_{CC}}{CE} \ge V_{CC} - 0.3V,$		300	μΑ
t <sub>CDR</sub> <sup>[3]</sup>	Chip Deselect to Data Retention Time	$V_{IN} \ge V_{CC} - 0.3V$ or $V_{IN} \le 0.3V$	0		ns
t <sub>R</sub>	Operation Recovery Time		200		μS

#### **Data Retention Waveform**

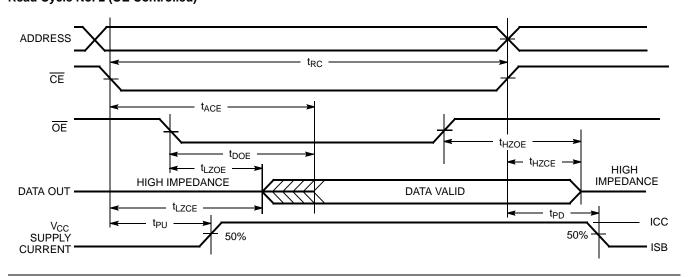


## **Switching Waveforms**

Read Cycle No. 1<sup>[9, 10]</sup>



## Read Cycle No. 2 (OE Controlled)[10, 11]



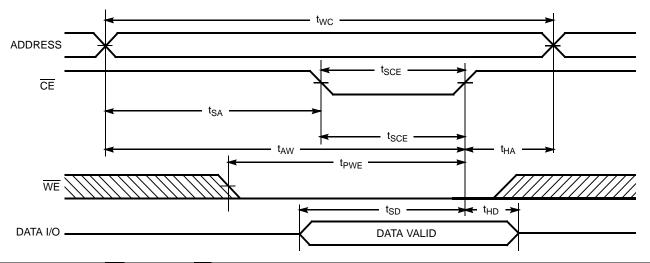
#### Notes:

- 9. Device is continuously selected.  $\overline{OE}$ ,  $\overline{CE} = V_{II}$ .
- 10. WE is HIGH for read cycle.
- 11. Address valid prior to or coincident with  $\overline{CE}$  transition LOW.

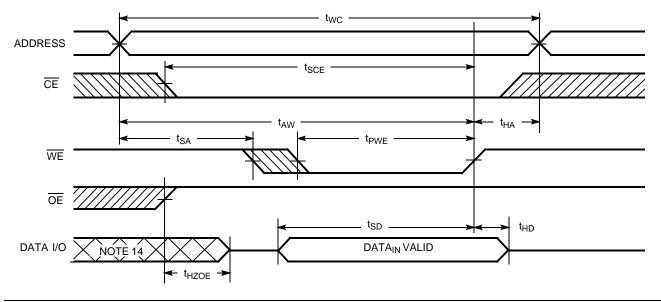


## Switching Waveforms (continued)

Write Cycle No. 1 (CE Controlled)[12, 13]



Write Cycle No. 2 (WE Controlled, OE HIGH During Write)[12, 13]



- Notes:

  12. Data I/O is high impedance if  $\overline{OE} = V_{IH}$ .

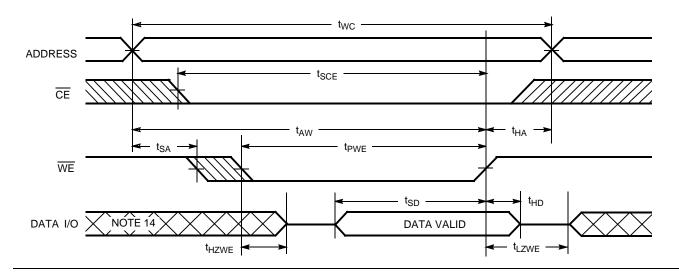
  13. If  $\overline{CE}$  goes HIGH simultaneously with WE going HIGH, the output remains in a high-impedance state.

  14. During this period the I/Os are in the output state and input signals should not be applied.



## Switching Waveforms (continued)

Write Cycle No. 3 (WE Controlled, OE LOW)[13]



## **Truth Table**

CE	OE	WE	I/O <sub>0</sub> -I/O <sub>7</sub>	Mode	Power
Н	Х	Х	High Z	Power-Down	Standby (I <sub>SB</sub> )
Х	Х	Х	High Z	Power-Down	Standby (I <sub>SB</sub> )
L	L	Н	Data Out	Read	Active (I <sub>CC</sub> )
L	Х	L	Data In	Write	Active (I <sub>CC</sub> )
L	Н	Н	High Z	Selected, Outputs Disabled	Active (I <sub>CC</sub> )

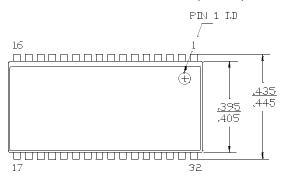
## **Ordering Information**

Speed (ns)	Ordering Code	Package Name	Package Type	Operating Range
12	CY7C1019B-12VC	V33	32-Lead 400-Mil Molded SOJ	Commercial
	CY7C1019B-12ZC	ZS32	32-Lead TSOP Type II	
	CY7C1019B-12ZXC	ZS32	32-Lead TSOP Type II (Pb -Free )	
15	CY7C1019B-15VC	V33	32-Lead 400-Mil Molded SOJ	Commercial
	CY7C1019B-15VI	V33	32-Lead 400-Mil Molded SOJ	Industrial
	CY7C1019B-15ZC	ZS32	32-Lead TSOP Type II	Commercial
	CY7C1019B-15ZXC	ZS32	32-Lead TSOP Type II (Pb -Free)	
	CY7C1019B-15ZI	ZS32	32-Lead TSOP Type II	Industrial

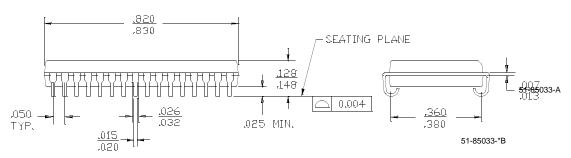


## **Package Diagrams**

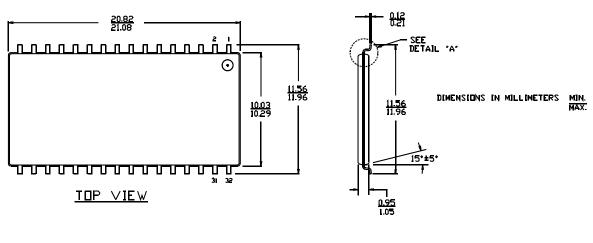
#### 32-Lead (400-mil) Molded SOJ V33

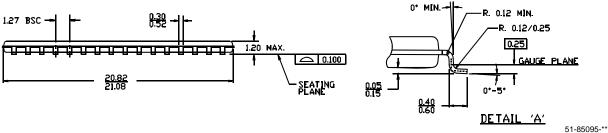


DIMENSIONS IN INCHES MIN.



#### 32-Lead TSOP II ZS32





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## **Document History Page**

	Document Title: CY7C1019B/CY7C10191B 128K x 8 Static RAM Document Number: 38-05026						
REV.	ECN NO.	Issue Date	Orig. of Change	Description of Change			
**	109949	09/25/01	SZV	Change from Spec number: 38-01115 to 38-05026			
*A	116170	08/14/02	HGK	SOJ (400-mil) package outline replacing incorrect SOJ package     Pin for pin compatible with CY7C1019     Industrial packages added to Ordering Information			
*B	397875	See ECN	NXR	Changed address of Cypress Semiconductor Corporation on Page# 1 from "3901 North First Street" to "198 Champion Court" Updated the Ordering Information Table on page # 6.			